FAN1654

1.5A LDO, DDR Bus Termination Regulator

Features

- Sinks and sources 1A continuous, 1.5A peak
- -40°C to +125°C Operating Range
- Load regulation: (VDDQ/2) ± 40mV
- 5mA VREF buffer tracks VTT
- On-chip thermal limiting
- Power-enhanced eTSSOPTM-16 package
- Low Current Shutdown Mode
- Output Short Circuit Protection

Applications

DDR terminators

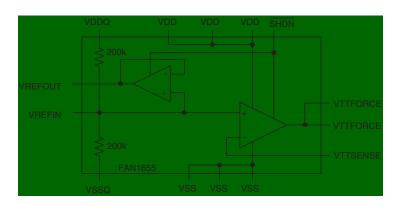
Description

The FAN1654 is a low-cost bi-directional LDO specifically designed for terminating DDR memory bus. It can both sink and source up to 1A continuous, 1.5A peak, providing enough current for most DDR applications. Load regulation meets the JEDEC spec, VTT = $(VDDQ/2) \pm 40mV$.

The FAN1654 includes a buffered reference voltage capable of supplying up to 5mA current. On-chip thermal limiting provides protection against a combination of power overload and ambient temperature that would create an excessive junction temperature. A shutdown input puts the FAN1654 into a low power mode for laptop computer applications.

The FAN1654 regulator is available in a power-enhanced eTSSOPTM-16 package, and the standard SOIC-14

Block Diagram



Pin Assignments



16-Lead Plastic eTSSOP-16 $\theta_{JC} = 4^{\circ}C/W^{*}$

*With package power slug soldered to 0.5 square inch copper area over backside ground plane of internal power plane

VSSQ 🗆 1	14 SHDN
VREFOUT □ 2	13 VREFIN
VDDQ □ 3	12 VTTSENSE
VDD ☐ 4	11 🗆 VSS
VDD □ 5	10 🗆 VDD
VTTFORCE ☐ 6	9 VTTFORCE
VSS □ 7	8 🗆 VSS

14-Lead Plastic SOIC $\theta_{JC} = 37^{\circ}\text{C/W}, \, \theta_{JA} = 88^{\circ}\text{C/W}$

Pin Definitions

Pin Number*	Pin Name	Pin Function Description		
1, 2, 7 (4, 5, 10)	VDD	VDD. Input power for the LDO.		
3, 6 (6, 9)	VTTFORCE	VTT Force Output.		
4, 5, 8 (7, 8, 11)	VSS	Power Ground.		
10 (12)	VTTSENSE	VTT Sense. Feedback for remote sense of the VTT voltage.		
11 (13)	VREFIN	VREFIN. Alternative input for direct control of VTTOUT and VREFOUT.		
12 (14)	SHDN	Shutdown. This active low shutdown turns off both VTT and VREFOUT. This pin has an internal pull-down, and must be externally driven high for the IC to bon.		
13 (1)	VSSQ	Signal Ground.		
14 (2)	VREFOUT	Buffered Voltage Reference Output.		
15 (3)	VDDQ	VDDQ Input. Attach this pin to the VDDQ supply to generate VTT and VREFOUT.		
9,16	NC	No Internal Connection		

^{*} Pin Numbers in brackets are for the SOIC-14 package

Typical Application

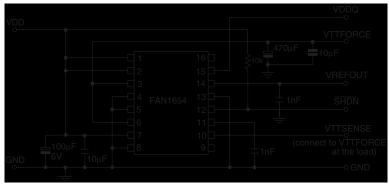
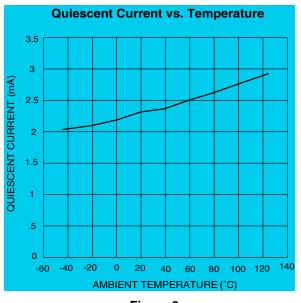


Figure 1. (eTSSOP pinout shown)

FAN1654 PRODUCT SPECIFICATION

Typical Performance Characteristics



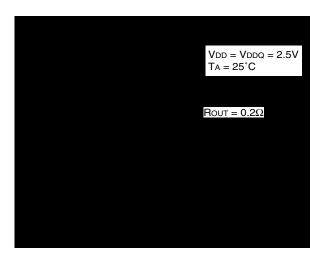


Figure 2 Figure 3

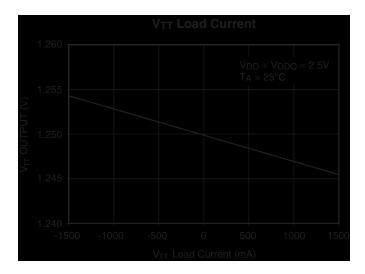


Figure 4

Absolute Maximum Ratings

Supply Voltage VDD, VDDQ	6V			
Junction Temperature, T _J	150°C			
Storage Temperature	-65 to 150°C			
Lead Soldering Temperature, 10 seconds	300°C			
Power Dissipation, P _D	1.4W			

Recommended Operating Conditions

Parameter	Conditions	Min.	Тур.	Max.	Units
Supply Voltage VDD		2.3	2.5	3.6	V
Supply Voltage VDDQ		2.2	2.5	3.0	V
Ambient Operating Temperature		-40		125	°C
VREFIN		1.1	1.25	1.5	V

Electrical Characteristics

(VDD = VDDQ = $2.5V \pm 0.2V$, and $T_A = 25^{\circ}C$ using circuit in Figure 1, unless otherwise noted.) The • denotes specifications which apply over the specified operating temperature range.

Parameter	Conditions		Min.	Тур.	Max.	Units
VTT Output Voltage	I _{OUT} = 0A, VREFIN = open					
	VDDQ = 2.3V	•	1.135	1.150	1.165	V
	VDDQ = 2.5V	•	1.235	1.250	1.265	V
	VDDQ = 2.7V	•	1.335	1.350	1.365	V
	$I_{OUT} = \pm 1A$, VREFIN = open		1.110	1.150	1.190	V
	VDDQ = 2.3V		1.210	1.250	1.290	V
	VDDQ = 2.5V		1.310	1.350	1.390	v
	VDDQ = 2.7V					
VTT Output Slew Rate	Cload = 10µF			0.1		V/µsec
VTT Leakage Current	SHDN = 0V	•	-50		50	μΑ
VTT Current Limit				±2		Α
VREFIN Input Impedance				100		KΩ
VREFOUT Output Voltage	No load					
	VREFIN = 1.150V	•	1.145	1.150	1.155	V
	VREFIN = 1.250V		1.245	1.250	1.255	V
	VREFIN = 1.350V	•	1.345	1.350	1.355	V
VREFOUT Output Current	VDDQ = 2.3V	•	-5		5	mA
VREFOUT Leakage Current	SHDN = 0V	•	-10		10	μA
SHDN Logic High		•	1.667			V
SHDN Logic Low		•			0.800	V
IDD Supply Current	No load, SHDN = 2.7V	•		3	10	mA
VDDQ Leakage Current	SHDN = 0V	•		6	10	μΑ
VDD Leakage Current	SHDN = 0V	•		3	50	μΑ
SHDN Input Current	<u>SHDN</u> = 2.7V	•		50	75	μΑ
Over-Temperature Shutdown				155		°C
Over-Temperature Hysteresis				30		°C

FAN1654 PRODUCT SPECIFICATION

Mechanical Dimensions



Mechanical Dimensions 14-Lead SOIC

NOTES:

- 1. This package conforms to JEDEC MS-012, variation AB, ISSUEC dated May, 1990.
- 2. All dimensions are in millimeters
- 3. Standard lead finished 200 microinches / 5.08 microns min. Lead/Tin (solder) oncopper



Ordering Information

Product Number	Package
FAN1654MTF	eTSSOP-16
FAN1654MTFX	eTSSOP-16 in tape and reel
FAN1654M	SOIC-14
FAN1654MX	SOIC-14 in tape and reel

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